SN5406, SN5416, SN7406, SN7416 HEX INVERTER BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS SDLS031A – DECEMBER 1983 – REVISED DECEMBER 2001

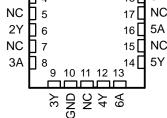
SN

- Convert TTL Voltage Levels to MOS Levels
- High Sink-Current Capability
- Input Clamping Diodes Simplify System Design
- Open-Collector Drivers for Indicator Lamps and Relays
- Inputs Fully Compatible With Most TTL Circuits

description

These TTL hex inverter buffers/drivers feature high-voltage open-collector outputs for interfacing with high-level circuits (such as MOS) or for driving high-current loads (such as lamps or relays), and also are characterized for use as inverter buffers for driving TTL inputs. The SN5406 and SN7406 have minimum breakdown voltages of 30 V. The SN5416 and SN7416 have minimum breakdown voltages of 15 V. The maximum sink current is 30 mA for the SN5406 and SN7406 sN7

| N5406, SN5416 SN7406 D, N, O SN7416 D OF (TOP V | R NS PACKAGE R N PACKAGE |
|--|--|
| 1A [1 1Y [2 2A [3 2Y [4 3A [5 3Y [6 GND [7 | 14 V _{CC} 13 6A 12 6Y 11 5A 10 5Y 9 4A 8 4Y |
| SN5406 FK (TOP VI | |
| $2A \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 4 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 4 \\ 5 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix} 2 \\ 3 \end{bmatrix} \begin{bmatrix} 2 \\ 1 \end{bmatrix} \begin{bmatrix}$ | 20 19 17 0 NC |



NC - No internal connection

| TA | PAC | KAGE [†] | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-----------|-------------------|--------------------------|---------------------|
| | | Tube | SN7406D | 7400 |
| 0°C to 70°C | SOIC – D | Tape and reel | SN7406DR | 7406 |
| | 50IC - D | Tube | SN7416D | 7416 |
| | | Tape and reel | 7410 | |
| | PDIP – N | Tube | SN7406N | SN7406N |
| | FDIF – N | edur | SN7416N | SN7416N |
| | SOP – NS | Tape and reel | SN7406NSR | SN7406 |
| | CDIP – J | Tube | SNJ5406J | SNJ5406J |
| | CDIP – J | Tube | SNJ5416J | SNJ5416J |
| –55°C to 125°C | CDIP – W | Tube | SNJ5406W | SNJ5406W |
| | | Tube | SNJ5416W | SNJ5416W |
| | LCCC – FK | Tube | SNJ5406FK | SNJ5406FK |

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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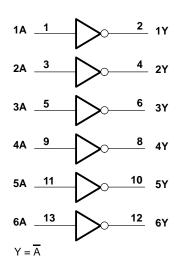
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



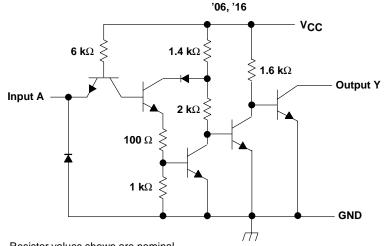
Copyright © 2001, Texas Instruments Incorporated On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

SN5406, SN5416, SN7406, SN7416 **HEX INVERTER BUFFERS/DRIVERS** WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS SDLS031A - DECEMBER 1983 - REVISED DECEMBER 2001

logic diagram (positive logic)



schematic (each buffer/driver)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature (unless otherwise noted)[†]

| Supply voltage, V _{CC} (see Note 1) | |
|--|----------------|
| Input voltage, VI (see Note 1) | 5.5 V |
| Output voltage, V _O (see Notes 1 and 2): SN5406, SN7406 | 30 V |
| SN5416, SN7416 | 15 V |
| Package thermal impedance, θ_{JA} (see Note 3): D package | 86°C/W |
| N package | 80°C/W |
| NS package | |
| Storage temperature range, T _{stg} | –65°C to 150°C |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Voltage values are with respect to network ground terminal.

2. This is the maximum voltage which should be applied to any output when it is in the off state.

3. The package thermal impedance is calculated in accordance with JESD 51-7.



SN5406, SN5416, SN7406, SN7416 **HEX INVERTER BÚFFERS/DRIVERS** WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

SDLS031A - DECEMBER 1983 - REVISED DECEMBER 2001

recommended operating conditions

| | | | | SN5406 SN5416 | | | UNIT | | |
|-----|--------------------------------|-----|-----|------------------|------|-----|------|-----|----|
| | | | MIN | NOM | MAX | MIN | NOM | MAX | |
| Vcc | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V | |
| VIH | High-level input voltage | 2 | | | 2 | | | V | |
| VIL | Low-level input voltage | | | | 0.8 | | | 0.8 | V |
| Val | High level output voltage | '06 | | | 30 | | | 30 | V |
| ∨он | High-level output voltage | '16 | | | 15 | | | 15 | v |
| IOL | Low-level output current | | | 30 | | | 40 | mA | |
| ТА | Operating free-air temperature | | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | | SN5406 SN5416 | | | | UNIT | | | |
|-----------------|------------------------|-------------------------|-------------------------|------------------|-----|------|------|------|------|----|--|
| | | | MIN | түр‡ | MAX | MIN | TYP‡ | MAX | | | |
| VIK | $V_{CC} = MIN,$ | I _I = -12 mA | | | | -1.5 | | | -1.5 | V | |
| IOH | V _{CC} = MIN, | $V_{IL} = 0.8 V,$ | V _{OH} = § | | | 0.25 | | | 0.25 | mA | |
| VOL | V _{CC} = MIN, | V _{IH} = 2 V | I _{OL} = 16 mA | | | 0.4 | | | 0.4 | V | |
| VOL | $v_{CC} = wint,$ | VIH = 2 ∨ | I _{OL} = ¶ | | | 0.7 | 0.7 | | | | |
| lj | V _{CC} = MAX, | V _I = 5.5 V | | | | 1 | | | 1 | mA | |
| ΙΗ | V _{CC} = MAX, | V _{IH} = 2.4 V | | | | 40 | | | 40 | μA | |
| ۱ _{IL} | V _{CC} = MAX, | $V_{IL} = 0.4 V$ | | | | -1.6 | | | -1.6 | mA | |
| ICCH | $V_{CC} = MAX$ | | | | 30 | 48 | | 30 | 48 | mA | |
| ICCL | V _{CC} = MAX | | | | 32 | 51 | | 32 | 51 | mA | |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

⁴ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. § $V_{OH} = 30 \text{ V}$ for '06 and 15 V for '16. ¶ $I_{OL} = 30 \text{ mA}$ for SN54' and 40 mA for SN74'.

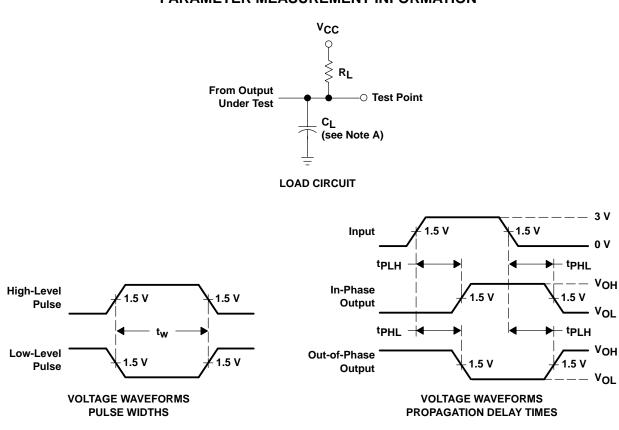
switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS | MIN | ТҮР | МАХ | UNIT |
|------------------|-----------------|----------------|------------------------------------|-----|-----|-----|------|
| ^t PLH | ٨ | Y | D 440.0 0 45 -5 | | 10 | 15 | |
| ^t PHL | A | Y | $R_L = 110 \Omega$, $C_L = 15 pF$ | | 15 | 23 | ns |



SN5406, SN5416, SN7406, SN7416 **HEX INVERTER BUFFERS/DRIVERS** WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

SDLS031A - DECEMBER 1983 - REVISED DECEMBER 2001



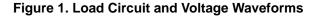
PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

B. In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.

C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f \leq 7 ns, t_f \leq 7 ns.

D. The outputs are measured one at a time with one input transition per measurement.







PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| JM38510/00801BCA | ACTIVE | CDIP | J | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 00801BCA | Samples |
| JM38510/00801BDA | ACTIVE | CFP | W | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 00801BDA | Samples |
| M38510/00801BCA | ACTIVE | CDIP | J | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 00801BCA | Samples |
| M38510/00801BDA | ACTIVE | CFP | W | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | JM38510/ 00801BDA | Samples |
| SN5406J | ACTIVE | CDIP | J | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN5406J | Samples |
| SN5416J | ACTIVE | CDIP | J | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SN5416J | Samples |
| SN7406D | LIFEBUY | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7406 | |
| SN7406DE4 | LIFEBUY | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7406 | |
| SN7406DG4 | LIFEBUY | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7406 | |
| SN7406DR | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7406 | Samples |
| SN7406DRE4 | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7406 | Samples |
| SN7406DRG4 | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7406 | Samples |
| SN7406N | ACTIVE | PDIP | N | 14 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN7406N | Samples |
| SN7406NE4 | ACTIVE | PDIP | N | 14 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN7406N | Samples |
| SN7406NSR | ACTIVE | SO | NS | 14 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | SN7406 | Samples |
| SN7416D | LIFEBUY | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7416 | |
| SN7416DE4 | LIFEBUY | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7416 | |
| SN7416DR | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | 7416 | Samples |
| SN7416N | ACTIVE | PDIP | N | 14 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | 0 to 70 | SN7416N | Samples |
| SN7416NSR | ACTIVE | SO | NS | 14 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | 0 to 70 | SN7416 | Samples |

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| SNJ5406FK | ACTIVE | LCCC | FK | 20 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ5406FK | Samples |
| SNJ5406J | ACTIVE | CDIP | J | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ5406J | Samples |
| SNJ5406W | ACTIVE | CFP | W | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ5406W | Samples |
| SNJ5416J | ACTIVE | CDIP | J | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ5416J | Samples |
| SNJ5416W | ACTIVE | CFP | W | 14 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | SNJ5416W | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN5406, SN5416, SN7406, SN7416 :

- Catalog : SN7406, SN7416
- Military : SN5406, SN5416

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

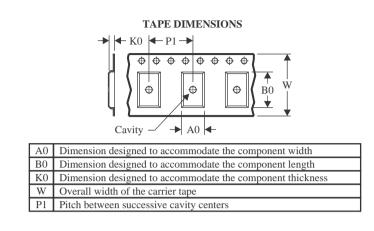
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STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



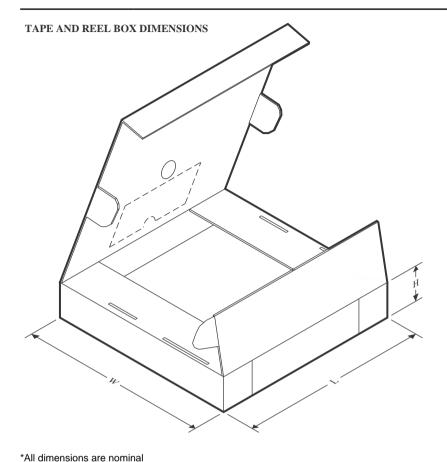
| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| SN7406DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN7406DRG4 | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN7406DRG4 | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN7406NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN7416DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN7416NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |



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PACKAGE MATERIALS INFORMATION

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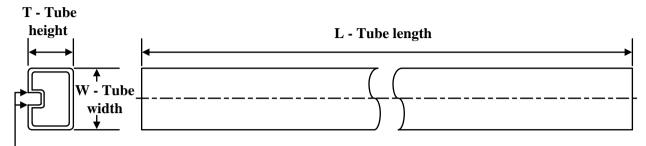
| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN7406DR | SOIC | D | 14 | 2500 | 340.5 | 336.1 | 32.0 |
| SN7406DRG4 | SOIC | D | 14 | 2500 | 356.0 | 356.0 | 35.0 |
| SN7406DRG4 | SOIC | D | 14 | 2500 | 340.5 | 336.1 | 32.0 |
| SN7406NSR | SO | NS | 14 | 2000 | 356.0 | 356.0 | 35.0 |
| SN7416DR | SOIC | D | 14 | 2500 | 356.0 | 356.0 | 35.0 |
| SN7416NSR | SO | NS | 14 | 2000 | 356.0 | 356.0 | 35.0 |

TEXAS INSTRUMENTS

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TUBE



- B - Alignment groove width

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| JM38510/00801BDA | W | CFP | 14 | 1 | 506.98 | 26.16 | 6220 | NA |
| M38510/00801BDA | W | CFP | 14 | 1 | 506.98 | 26.16 | 6220 | NA |
| SN7406D | D | SOIC | 14 | 50 | 506.6 | 8 | 3940 | 4.32 |
| SN7406DE4 | D | SOIC | 14 | 50 | 506.6 | 8 | 3940 | 4.32 |
| SN7406DG4 | D | SOIC | 14 | 50 | 506.6 | 8 | 3940 | 4.32 |
| SN7406N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN7406N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN7406NE4 | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN7406NE4 | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN7416D | D | SOIC | 14 | 50 | 506.6 | 8 | 3940 | 4.32 |
| SN7416DE4 | D | SOIC | 14 | 50 | 506.6 | 8 | 3940 | 4.32 |
| SN7416N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SN7416N | N | PDIP | 14 | 25 | 506 | 13.97 | 11230 | 4.32 |
| SNJ5406FK | FK | LCCC | 20 | 1 | 506.98 | 12.06 | 2030 | NA |
| SNJ5406W | W | CFP | 14 | 1 | 506.98 | 26.16 | 6220 | NA |
| SNJ5416W | W | CFP | 14 | 1 | 506.98 | 26.16 | 6220 | NA |

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14



FK 20

8.89 x 8.89, 1.27 mm pitch

GENERIC PACKAGE VIEW

LCCC - 2.03 mm max height

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





GENERIC PACKAGE VIEW

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



J0014A



PACKAGE OUTLINE

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE



NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



J0014A

EXAMPLE BOARD LAYOUT

CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE





D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.





NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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